	Material Compo © Copyright 2005. IP international and Pan-	C, Bannockb	ourn, Illinois. A	All rights reserved u ntions.	nder both	This docume level parts, t	ent is a declara he declaration	tion of t encomp	he substance asses all low	s within the er level mat	manufactur erials for wl	er listed in hich the m	tem. Note: nanufacture	if the item is an as er has engineering	ssembly with low responsibility.	
752-21.1					Form Type Distribute						eous Materia	cials and Mfg Information				
upplie	r Information															
Company name* Con				Company unique ID			Unique ID Authority					Response Date*				
nsemi												2025-07-15				
ontact N	Jame	Title - Contact				Phone - Contact*					Email - Contact*					
Product-	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
uthorize	ed Representative*	Title - Representative				Phone - Representative*				Email - Representative*						
roduct-	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
	Requester Item Number Mfr Item I LM317LE		n Number Mfr Item Name				Effective Dat	ve Date Version Manufacturing Sit		ring Site		Weight*	UOM	Unit Type		
			BZRAG	ZRAG ANA 100MA ADJUST OUT VREG			2025-07-15 CNF				-	198.01	mg	Each		
Ianufa	cturing Proccess Informat	ion						-							L	
	Terminal Plating / Grid Array Material		Cerminal Base Alloy J-STD-020 MS		L Rating	Peak Process Body Temperate		ure Max Time at Peak Temp		Temperat	ure Num	ber of Reflow Cy	cles			
Matte Tin (Sn) - annealed		CU Alloy NA			0 C		30 sec		secon	ds 3						
omments	8															
or more	information regarding material of	composition	please refer to	o page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.2	mg	Supplier	Silicon (Si)	7440-21-3		3.2	mg
Die Attach	5.15	mg	Supplier	Silver (Ag)	7440-22-4		4.3775	mg
			Supplier	Phenolic Resin	Proprietary Data		0.7725	mg
Lead Frame	80.67	mg	Supplier	Silver (Ag)	7440-22-4		0.0081	mg
			Supplier	Iron (Fe)	7439-89-6		0.0807	mg
			Supplier	Copper (Cu)	7440-50-8		80.5571	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0242	mg
Mold Compound-Black	106.15	mg		Phenol Resin	proprietary data		10.615	mg
			Supplier	Carbon Black (C)	1333-86-4		1.0615	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		81.7355	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		12.738	mg
Plating	2.74	mg	Supplier	Tin (Sn)	7440-31-5		2.74	mg
Wire Bond - Au	0.1	mg	Supplier	Gold (Au)	7440-57-5		0.1	mg